



Customer Information Notification

201404013I

Issue Date: 05-Jun-2014

Effective Date: 06-Jul-2014

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to [view this notification online](#)



QUALITY

Management Summary

- The datasheet is updated, as some corrections were required.

Change Category

<input type="checkbox"/> Wafer Fab process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab materials	<input type="checkbox"/> Assembly Materials	<input checked="" type="checkbox"/> Electrical spec./Test coverage	<input type="checkbox"/> Mechanical Specification
<input type="checkbox"/> Wafer Fab location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Test Location	<input type="checkbox"/> Packing/Shipping/Labeling

Update datasheet for LPC177x / LPC178x

Information Notification

The product datasheet LPC177X / LPC178X has been updated to rev. 5

- Some parameters in the datasheet are updated, specifically the static characteristics and EMC timing, see attachment.

- See datasheet revision history sheet (page 115) for more details.

Why do we issue this Information Notification

- The update is made to ensure that the correct information is in the datasheet.

- To notify customers that the product datasheet is updated.

Identification of Affected Products

Product identification does not change.

Impact

No impact.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Not applicable, no changes in the product itself, this is only a datasheet update.

Remarks

- No process / fab change.
- No assembly / final test location change.
- No design change.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Emile Busink
Position QA engineering Logic & Smart Analog / MCU
e-mail address emile.busink@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

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